

Sponsorship & Exhibition Application Form:

Date: _____

Name of the company:

Postal address:

Invoice address (if different from above):

Name of the contact person:

Phone:

Fax:

E-mail:

Sponsorship

- | | |
|--|---------------|
| <input type="checkbox"/> Diamond Package: | 1,800,000 JPY |
| <input type="checkbox"/> Platinum Package: | 1,000,000 JPY |
| <input type="checkbox"/> Gold Package: | 500,000 JPY |

Exhibition

- | | |
|--|-------------|
| <input type="checkbox"/> One booth: | 200,000 JPY |
| <input type="checkbox"/> Two booths | 400,000 JPY |
| <input type="checkbox"/> Three booths: | 600,000 JPY |
| <input type="checkbox"/> Four booths: | 800,000 JPY |

Indicate the booth number when there is hope regarding the location.

First choice: _____ Second choice: _____ Third choice: _____

Additional Sponsorship Opportunities

- | | |
|---|-------------|
| <input type="checkbox"/> Sponsorship of 1 Relax Area: | 200,000 JPY |
| <input type="checkbox"/> Co-Sponsorship of Women and Young Professionals
in Circuits and Systems Reception | 400,000 JPY |
| <input type="checkbox"/> Co-Sponsorship of Student Luncheon Meeting: | 100,000 JPY |
| <input type="checkbox"/> Lanyard: | 400,000 JPY |
| <input type="checkbox"/> Branded pen, notepad, or other gift: | 100,000 JPY |

Note:

Contact:

ISCAS 2019 Industry & Exhibition Co-Chairs

Akihiko Sugiyama (NEC Corporation)

Takayuki Nakachi (NTT)

Martins Rui (Univ. of Macau)

E-mail: exhibit@iscas2019.org